**Product data sheet** 

## 1. General description

Quad high-speed switching diodes with common anode configurations encapsulated in a leadless ultra small DFN1412-6 (SOT1268) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- High switching speed: t<sub>rr</sub> ≤ 4 ns
- Low leakage current
- Reverse voltage V<sub>R</sub> ≤ 90 V
- Low capacitance C<sub>d</sub> ≤ 2 pF
- Ultra small SMD plastic package
- AEC-Q101 qualified

## 3. Applications

- · High-speed switching
- · General-purpose switching

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit		
Per diode	er diode								
I <sub>F</sub>	forward current	single diode loaded; T <sub>amb</sub> = 25 °C	[1]	-	-	375	mA		
I <sub>R</sub>	reverse current	$V_R$ = 80 V; pulsed; $T_j$ = 25 °C		-	-	0.5	μA		
V <sub>F</sub>	forward voltage	$I_F$ = 150 mA; $t_p \le 300$ μs; $\overline{o} \le 0.02$ ; $T_j$ = 25 °C		-	-	1.25	V		
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	90	V		
t <sub>rr</sub>	reverse recovery time	$I_F$ = 10 mA; $I_R$ = 10 mA; $R_L$ = 100 Ω; $I_{R(meas)}$ = 1 mA; $T_{amb}$ = 25 °C		-	-	4	ns		

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



## Quad high-speed switching diodes

# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)		
2	K2	cathode (diode 2)	7 6	K1 A1,2
3	A3,4	com. anode (diodes 3, 4)	5	K2 <del>                                     </del>
4	K3	cathode (diode 3)		A3,4 K3
5	K4	cathode (diode 4)	3 8 4	
6	A1,2	com. anode (diodes 1, 2)		
7	A1,2	com. anode (diodes 1, 2)	Transparent top view	
8	A3,4	com. anode (diodes 3, 4)	DFN1412-6 (SOT1268)	

## 6. Ordering information

### **Table 3. Ordering information**

Type number	Package					
	Name	Description	Version			
BAW56SRA		plastic, thermal enhanced ultra thin small outline package; no leads; 6 terminals; 1.4 mm x 1.2 mm x 0.47 mm body	SOT1268			

## 7. Marking

#### Table 4. Marking codes

Type number	Marking code
BAW56SRA	A2

#### Quad high-speed switching diodes

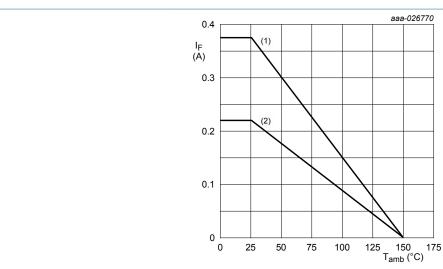
## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode				<u> </u>		
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	90	V
I <sub>F</sub>	forward current	single diode loaded; T <sub>amb</sub> = 25 °C	[1]	-	375	mA
		double diodes loaded; T <sub>amb</sub> = 25 °C	[1]	-	220	mA
I <sub>FSM</sub>	non-repetitive peak	$t_p$ = 100 $\mu$ s; $T_{j(init)}$ = 25 °C; square wave		-	4	Α
	forward current	$t_p$ = 1 ms; $T_{j(init)}$ = 25 °C; square wave		-	1.5	Α
		$t_p$ = 1 s; $T_{j(init)}$ = 25 °C; square wave		-	0.5	А
I <sub>FRM</sub>	repetitive peak forward current	$t_p \le 0.5 \text{ ms}; \delta \le 0.25$		-	1	А
Per device; o	ne diode loaded					
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	410	mW
			[2]	-	610	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated mounting pad for cathode 1cm<sup>2</sup>.



- (1) single diode loaded
- (2) double diode loaded

Fig. 1. Forward current as a function of ambient temperature; derating curve

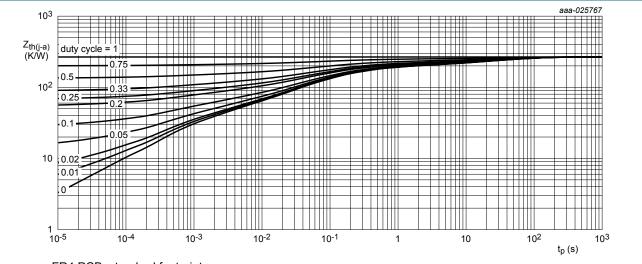
#### Quad high-speed switching diodes

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

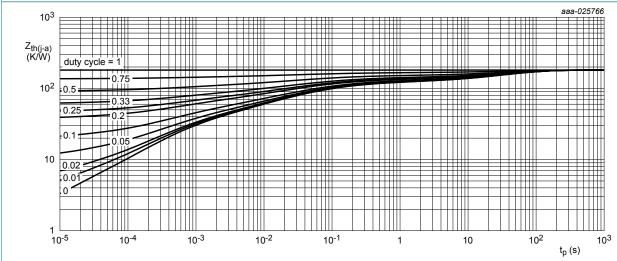
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub> thermal resistance junction to ambien	thermal resistance from	in free air	[1]	-	-	305	K/W
	junction to ambient	ction to ambient	[2]	-	-	205	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	40	K/W

- Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated mounting pad for cathode 1cm<sup>2</sup>.
- Soldering point of anode tab.



FR4 PCB, standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

#### Quad high-speed switching diodes

## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode	,					
V <sub>F</sub>	forward voltage	$I_F$ = 1 mA; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C	-	-	715	mV
		$I_F$ = 10 mA; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C	-	-	855	mV
		$I_F$ = 50 mA; $t_p$ ≤ 300 μs; δ ≤ 0.02; $T_j$ = 25 °C	-	-	1	V
		$I_F$ = 150 mA; $t_p \le 300$ μs; $δ \le 0.02$ ; $T_j$ = 25 °C	-	-	1.25	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 25 V; pulsed; T <sub>j</sub> = 25 °C	-	-	30	nA
		V <sub>R</sub> = 80 V; pulsed; T <sub>j</sub> = 25 °C	-	-	0.5	μΑ
		V <sub>R</sub> = 25 V; pulsed; T <sub>j</sub> = 150 °C	-	-	30	μΑ
		V <sub>R</sub> = 80 V; pulsed; T <sub>j</sub> = 150 °C	-	-	150	μΑ
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 0 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	-	2	pF
t <sub>rr</sub>	reverse recovery time	$I_F$ = 10 mA; $I_R$ = 10 mA; $R_L$ = 100 Ω; $I_{R(meas)}$ = 1 mA; $I_{amb}$ = 25 °C	-	-	4	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 10 \text{ mA}; t_r = 20 \text{ ns}$	-	-	1.75	V

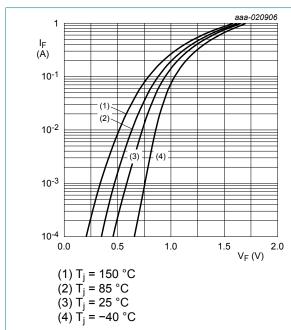


Fig. 4. Forward current as a function of forward voltage; typical values

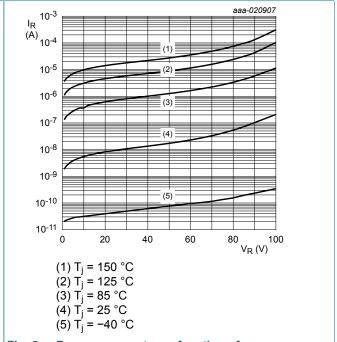


Fig. 5. Reverse current as a function of reverse voltage; typical values

#### Quad high-speed switching diodes

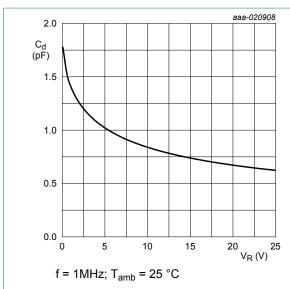
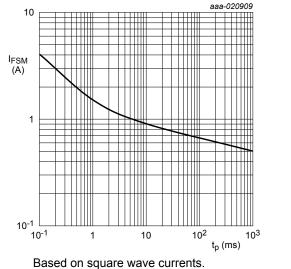


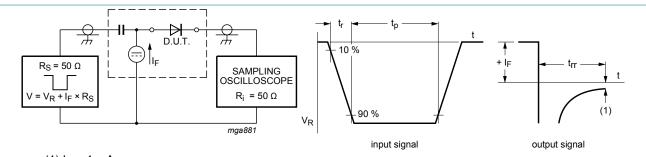
Fig. 6. Diode capacitance as a function of reverse voltage; typical values



Based on square wave currents.  $T_{amb} = 25 \, ^{\circ}\text{C}$ 

Fig. 7. Non-repetitive forward current as a function of pulse duration; maximum values

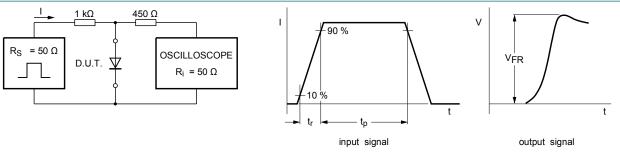
### 11. Test information



(1)  $I_R = 1 \text{ mA}$ 

Input signal: reverse pulse rise time  $t_r$  = 0.6 ns; reverse voltage pulse duration  $t_p$  = 100 ns; duty cycle  $\delta$  = 0.05 Oscilloscope: rise time  $t_r$  = 0.35 ns

#### Fig. 8. Reverse recovery time test circuit and waveforms



mga88

Input signal: forward pulse rise time  $t_r$  = 20 ns; forward current pulse duration  $t_p \ge 100$  ns; duty cycle  $\delta \le 0.005$ 

Fig. 9. Forward recovery voltage test circuit and waveforms

#### **Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

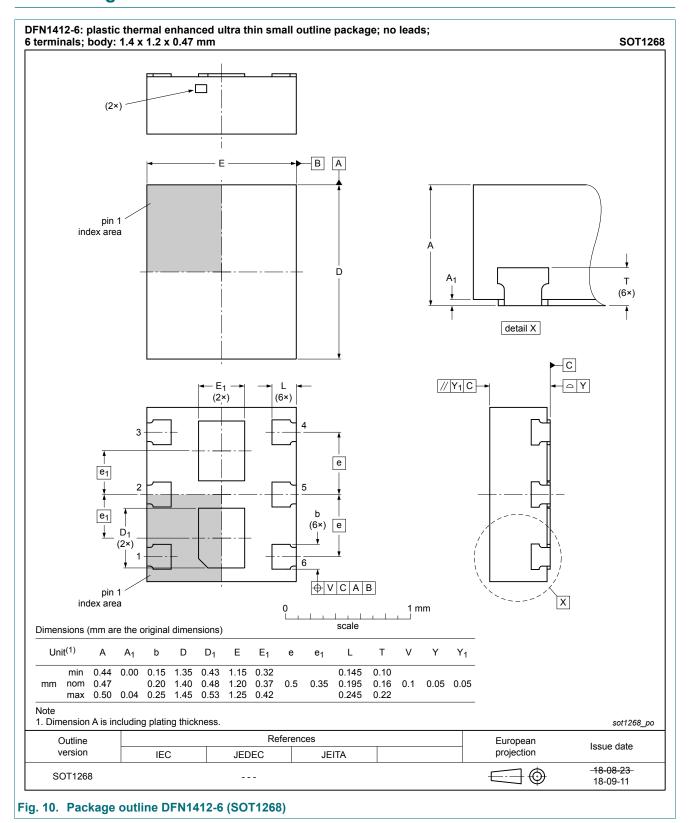
BAW56SRA

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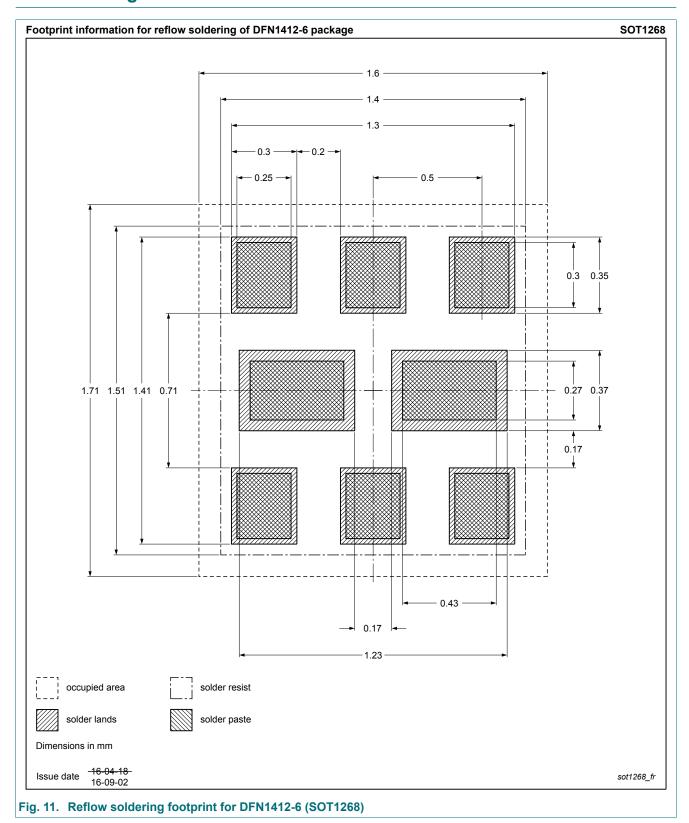
#### Quad high-speed switching diodes

## 12. Package outline



## Quad high-speed switching diodes

## 13. Soldering



## Quad high-speed switching diodes

# 14. Revision history

## Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
BAW56SRA v.2	20180914	Product data sheet	-	BAW56SRA v.1				
	Package outli	Package outline drawing updated: Unit T added						
BAW56SRA v.1	20170626	Product data sheet	-	-				

### Quad high-speed switching diodes

## 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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## Quad high-speed switching diodes

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